

**Amendments to the Specification:**

Please replace the paragraph beginning on page 1, line 13, with the following rewritten paragraph:

-- An example of an apparatus in which an electronic device is connected to a substrate by wire bonding is a surface acoustic wave resonator 100 shown in Fig. 8. The surface acoustic wave resonator 100 ~~comprises~~ includes a surface acoustic wave device 110 as an electronic device, a substrate 120, and a metal cover 130.--

Please replace the paragraph beginning on page 3, line 8, with the following rewritten paragraph:

-- The above-mentioned surface acoustic wave resonator 100 may, in some cases, be used as an in-vehicle part. In this case, significantly strong vibration such as the vibration of the engine or the vibration at the time of traveling is applied over a long time period. Therefore, it the surface acoustic wave resonator 100 is used under significantly severe conditions which cannot be compared with a normal household part.--

Please replace the paragraph beginning on page 3, line 16, with the following rewritten paragraph:

-- When such vibrations is are applied, the arch-shaped wired portion in a free state where there is no restraint of the wire thin line 140 vibrates in the above-mentioned conventional surface acoustic wave resonator 100. The vibration of the wire thin line 140 can be grasped as the vibration of a string whose both ends are fixed. At this time, when the frequency of the applied vibration and the characteristic frequency of the wire thin line 140 coincide with each other, the wire thin line 140 resonates with the applied vibration. As a result, the amplitude of

vibration of the wire thin line 140 is significantly increased exponentially, and the vibration is continued.--

Please replace the paragraph beginning on page 4, line 14, with the following rewritten paragraph:

-- An object advantage of the present invention is to provide an apparatus carrying an electronic device, in which high reliability can be ensured without a wire thin line being disconnected by being broken even if ultrasonic vibration at the time of or after mounting on a mother board or strong mechanical vibration of an in-vehicle mount or the like is applied for a long time period.--

Please replace the paragraph beginning on page 7, line 21, with the following rewritten paragraph:

-- The foregoing and other objects, features, aspects and advantages of the present invention will become more apparent from the following detailed description of the present invention when taken in conjunction with the accompanying drawings.--

Please replace the paragraph beginning on page 9, line 14, with the following rewritten paragraph:

-- The surface acoustic wave resonator 1 mainly comprises includes a surface acoustic wave device 10 serving as an electronic device, a substrate 20, and a metal cover 30. --

Please replace the paragraph beginning on page 24, line 9, with the following rewritten paragraph:

-- Although the present invention has been described and illustrated in detail, it is clearly understood that the same is by way of illustration and example only and is not to be taken by way of limitation, the spirit and scope of the present invention being limited only by the terms of the appended claims....